









PRODUCT DATASHEET



- ► PTH Lamp
- ▶ 5mm Round 8.7t
- ► Green (570nm)

NOG01L67 (Bulk) N0G01L67T (Taping)



5mm Round Lamp Compliant





5 mm Round Lamp

APPLICATIONS:

- Indicator
- Signal
- 3C Application

FEATURES:

- Package: PTH Lamp 5mm Round 8.6t
- Forward Current: 20mA
- Forward Voltage (typ.): 2.2V
- Luminous Intensity (typ.): 70mcd@20mA
- Colour: Green
- Wavelength: 570nm
- Viewing angle: 45°
- **Materials:**
 - Die: GaP
 - Resin: Epoxy (Green Diffused)
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+100°C
- **Grouping parameters:**
 - Forward voltage
 - Luminous intensity
 - **Domiant Wavelength**
- Soldering methods: Hand; Reflow soldering
- Preconditioning: acc. to JEDEC Level 3
- Packing: 500pcs/Bulk; 2000pcs/Taping



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	30	Ma
Peak Forward Current Duty 1/10@1KHz	I _{FP}	100	mA
Reverse Voltage	VR	5	V
Reverse Current @5V	I _R	10	μΑ
Power Dissipation	P _D	85	mW
Operating Temperature	TOPR	-40~+85	°C
Storage Temperature	T_{STG}	-40~+100	°C

Electrical & Optical Characteristics (Ta=25°C)

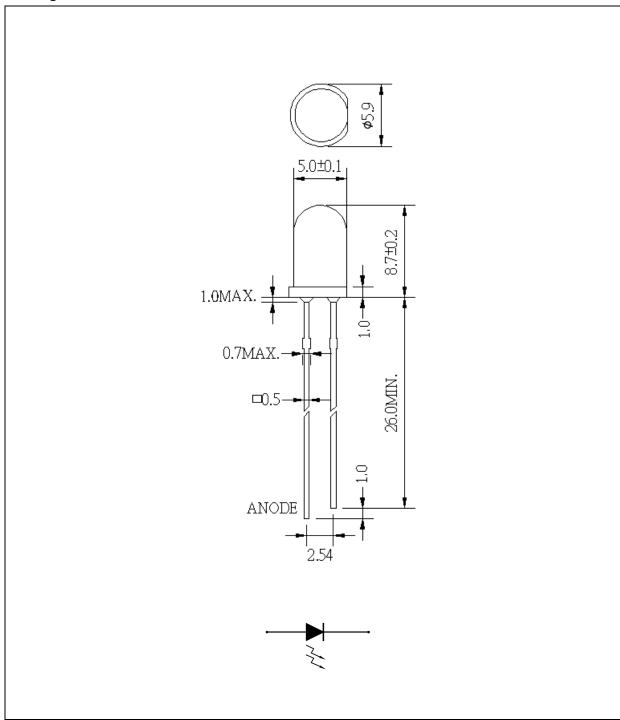
Parameter Symbol		Values			Unit	Test
Parameter Symbo	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	VF	1.8	2.2	2.6	V	I _F =20mA
Luminous Intensity	lv	40	70	90	mcd	I _F =20mA
Dominant Wavelength	λ_{D}	566	570	573	nm	I _F =20mA
Peak Wavelength	λ_{P}		568		nm	I _F =20mA
Spectral Line Half Bandwidth	Δλ		30		nm	I _F =20mA
Viewing Angle	2θ _{1/2}		45		deg	I _F =20mA

^{1.} Luminous intensity (Iv) $\pm 15\%$, Forward Voltage (V_F) $\pm 0.1V$, Viewing angle($2\theta_{1/2}$) $\pm 5\%$



OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 20mA):

Code	Min.	Max.	Unit
V	1.8	2.6	V

Luminous Intensity Classifications (I_F = 20mA):

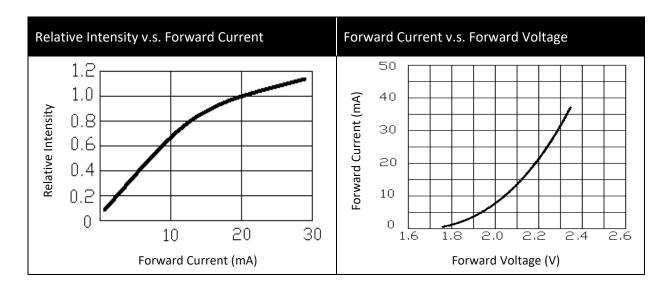
Code	Min.	Max.	Unit
I	40	90	mcd

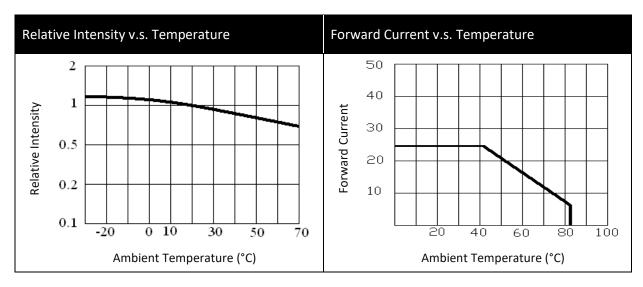
Wavelength Classifications (I_F = 20mA):

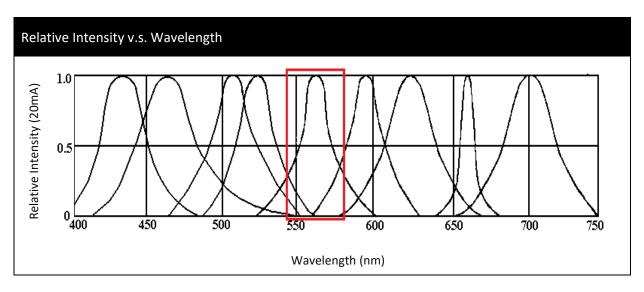
Code	Min.	Max.	Unit
G	566	573	nm



ELECTRO-OPTICAL CHARACTERISTICS (RED):







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RECOMMENDED SOLDERING PROFILE:

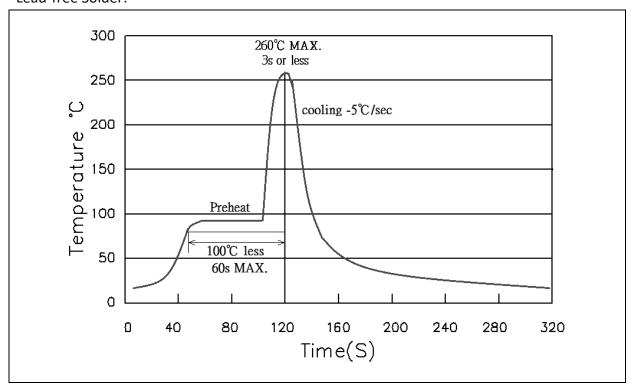
Hand Solder (Solder Iron):

• Temperature at tip of iron: 300°C Max.

Soldering Time: 3 seconds ± 1 sec.

• Maximum reflow soldering: 1 time.

Lead-free Solder:



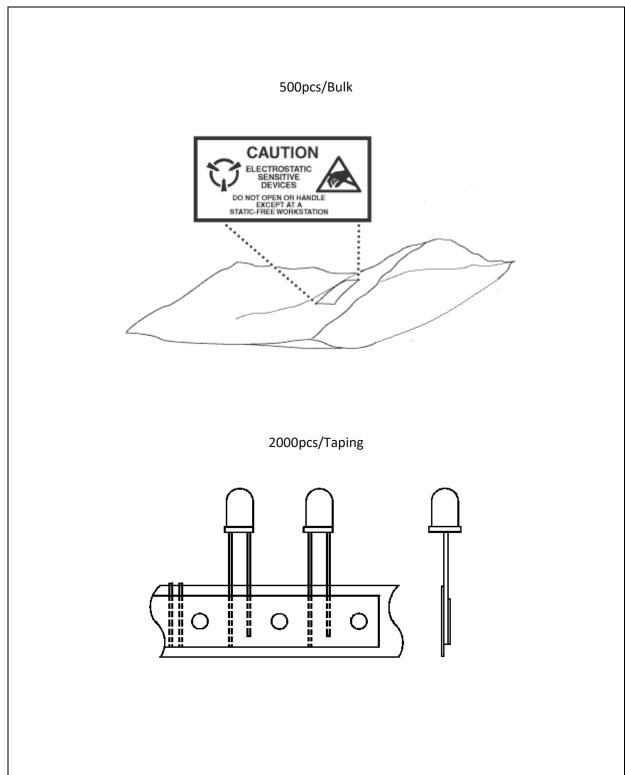
Note:

- 1. Maximum reflow soldering: 1 time.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

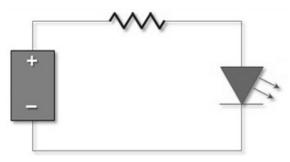
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	27/11/2017	Datasheet set-up.